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B/O FORM PTO 1595 (1/31/92) Patent and Trademark Office RECORDATION FORM COVER SHEET PATENTS ONLY



3260 U.S. PTO 11/377348

RENS.0015

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.				
1. Name of Conveying Party(ies): YOSHIO TAKAZAWA, TOSHIO YAMADA, SHINICHI OZAWA, TAKEO KANAI, MINORU KATOH, KOUDOU YAMAUCHI AND TOSHIHIRO ARAKI Additional names of conveying parties attached: □ Yes ☒ No 3. Nature of Conveyance: ☒ Assignment □ Merger □ Security Agreement □ Change of Name □ Other: Execution Date: December 15, 2003		2. Name and Address of Receiving Party(ies): (1) Name: Renesas Technology Corp. Address: 4-1, Marunouchi 2-chome City: Chiyoda-ku, Tokyo, Japan And (2) Name: Hitachi ULSI Systems Co., Ltd. Address: 22-1 Josuihoncho 5-chome City: Kodaira-shi, Tokyo, Japan		
 4. (a) Patent Application Number(s): If this document is being filed together with a new application, the execution date of the application is: Additional Numbers Attached. 		4. (b) Patent Numbers:		
Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:		6. Total Number of Applications and Patents Involved: 1		
Suite 1400	th LLP iew Park Dr.	7. Total Fee: \$40.00 (37 C.F.R. § 3.41) ⊠ Enclosed. ⊠ Authorized to be charged to deposit account.		
DO NOT USE THIS SPACE	ch, VA 22042	8. Deposit Account Number: 08-1480 ATTACH DUPLICATE COPY OF THIS PAGE IF PAYING BY DEPOSIT ACCOUNT		
9. Statement and Signature:				
To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document. March 17, 2006				
Stanley P. Fisher, Registration No. 24, 344 Juan Carlos A. Marquez, Registration No. 34,072				
Total number of pages comprising cover sheet:				

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ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp., and Hitachi ULSI Systems Co., Ltd.,

corporations organized under the laws of Japan,

located at 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan,

and 22-1, Josuihoncho 5-chome, Kodaira-shi, Tokyo, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp., and Hitachi ULSI Systems Co., Ltd.,

their successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Renesas Technology Corp., and Hitachi ULSI Systems Co., Ltd.,

their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp., and Hitachi ULSI Systems Co., Ltd.,

Signed on the date(s) indicated aside our signatures:

RECORDED: 03/17/2006

INVENTOR(S) (発明者フルネームサイン)			Date Signed (署名日)
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6)	Houdon Yamanchi	Koudou YAMAUCHI	15/December /2003
7)	Joshihiro araki	Toshihiro ARAKI	15 / December / 2003
8)			
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10)			

PATENT REEL: 017657 FRAME: 0829